SiPM Characterization

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Outline

• Characterisation, why?

Measurements without light (noise)

- Current-voltage characteristics
- Dark-rate
- Cross-talk & after-pulse probabilities

Measurements with light

- Gain-voltage dependence
- Photon detection efficiency
- Surface uniformity tests

Characterisation, why?

There are many different types of SiPM on the market

- Precise information is needed in order to choose the best device for a certain application
- Most manufacturers provide a data-sheet, however
 - Sometimes relevant information is missing
 - Manufacturer uses different definition of a property (PDE with cross-talk & after-pulse)
 - Large device to device variations
- Quality assurance for large scale experiments
- Learn something about SiPMs

IV measurement setup



IV diagram



IV diagram



IV diagram



Dark-rate



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Dark-rate



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- Discriminator generates logic pulse if input signal passes threshold
- Logic pulses are counted during fixed time interval -> calculate rate
- Dark-noise depends on:
 - Temperature
 - Reverse bias voltage (tunnel probability)
 - Discrimination threshold
- Automated with LABVIEW program





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Experimental setup



Temperature [°C] Temperature dependence Dark-rate vs. temperature 100 pixel (-100C) and 400 pixel (-050C) MPPC at $U_{over} = 1V$, 0.5pe threshold S10362-11-100C No180 Dark-rate [Hz] ₉01 20 S10362-11 [%] 18 S10362-11-050C No163 S10362-11 Rule of themb: The therpated darkrate couples for each temperature increase of 8 °C **10⁵** Cooling (if possible) 0 5 25 30 15 20 -10 -5 0 10 -10 -5 0 **Temperature** [°C]

Voltage dependence

Dark-rate vs. over-voltage

at room temperature, 0.5pe threshold



Dark-rate rises exponentially with the applied over-voltage

-> reduce over-voltage (this will lower the gain and the PDE!)

Threshold dependence (Optical cross-talk)



Expected probability for two pixels firing at the same time (~5ns) very low

 $P_{2pixel} \approx v_{dark} x \, \delta t = 1 MHz x 5 ns = 0.05\%$ But you see a O(10%) effect

Reason: optical cross-talk

A p-n junction in breakdown emits photons in the visible range (~ 3 x 10⁻⁵ per charge carrier*) If they reach a neighboring pixel additional breakdown can be caused Instantaneous effect!

How often do more than two pixels fire? -> threshold scan

* A. Lacaita, et al., IEEE Trans. Electron Devices ED-40 (1993) 577

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Threshold-scan setup





Cross-talk probability

Cross-talk probability vs. gain (pixel pitch) $gain = C_{pixel} \times U_{over}$, room temp. **50**∟ Cross-talk prob. [%] S10362-11-100C 45 S10362-11-050C SPMMICRO1020X13 **40** S10362-11-025C 35 (50µm) **30** (100**µ**m) 25 20 15 (25**u**m) 20**u**m) 10 3 3.5 1.5 2.5 0.5 2 1 Gain [10⁶]

Higher gain -> more photons + higher geiger efficiency (U_{over} = Gain/C_{pixel})

MPPC: At fixed gain values, small pixel devices have a higher crosstalk probability (average photon travel distance shorter)

SensL: small cross-talk due to trenches between pixels



After-pulses

- During avalanche breakdown charge 0 carriers can be trapped in silicon defects
- If they are released after a time 0 which is longer than the pixel recovery time, a second avalanche can be initiated
- After-pulses cannot be separated on 0 an event basis
- However it is possible to identify 0 after-pulses in a statistical analysis of the SiPM dark-rate
- Measure the time difference 0 between subsequent pulses



Overlaying waveforms (no light)

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time [ns]

Noise probability density distribution

of counts $P_{\mu}(n) = \frac{\mu^{\prime \prime} e^{-\mu}}{2}$ Probability to measure *n* dark-counts $\mu = t \cdot \nu_d$ within *t* at a given dark-rate of v_d : $P_{\mu}(0) = e^{-t\,\nu_d} = 1 - \int_0^{\iota} p_d dt'$ Probability to measure zero dark-counts: probability density From the above equation we $t \,
u_d$ $p_d = \nu_d e^$ can derive p_d density [1/s] Probability 900 probability density 800 0.8 $v_d = 1MHz$ 700 probability 600 probability 0.6 **500** $v_d = 1MHz$ **400** 0.4 300 200[†] 0.2 100 5 6 Time [s] time [s]

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average number















Δt distribution



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Additional corrections



Fast after-pulses will generate a smaller charge because of the pixel recovery time

effective gain:

$$G(\Delta t) = G_{\infty} \cdot \xi(\Delta t)$$
$$= G_{\infty} \cdot (1 - e^{-\Delta t/\tau_r})$$

 τ_r : pixel recovery time (R_q x C_{pixel})

$$P_{ap} = \frac{\int_0^\infty \xi \cdot n_{ap} \, d\Delta t}{\int_0^\infty \xi \cdot (n_{ap} + n_{tp}) \, d\Delta t}$$

$$n_{ap}(\Delta t) = N_{apf} / \tau_{apf} \cdot e^{-\Delta t / \tau_{apf}} + N_{aps} / \tau_{aps} \cdot e^{-\Delta t / \tau_{aps}}$$
$$n_{tp}(\Delta t) = N_{tp} / \tau_{tp} \cdot e^{-\Delta t / \tau_{tp}}$$

After-pulse probability



S10362-11-050C No163

Measurements with light

[Hz]

- SiPM is illuminated with short O(ns) LED pulses
- Amplified signal is fed into a charge to digital converter (QDC)
- Integration gate
 (typ. 20 100 ns)
- Integrate charge for each light pulse

Light-tight box Scaler Mmplifier Mmplifier Discriminator TDC At-Distributions HV Voltage Control LABVIEW Pulse-Rate

start with the dark-rate setup

0.5 pe threshold

[Hz]

- SiPM is illuminated with short O(ns) LED pulses
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[Hz]

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start with the dark-rate setup



- SiPM is illuminated with short O(ns) LED pulses
- Amplified signal is fed into a charge to digital converter (QDC)
- Integration gate (typ. 20 - 100 ns)
- Integrate charge for each light pulse

add a light source




Gain measurement

- SiPM is illuminated with short O(ns) LED pulses
- Amplified signal is fed into a charge to digital converter (QDC)
- Integration gate (typ. 20 - 100 ns)
- Integrate charge for each light pulse

add a light source





Photoelectron spectrum



- Amplification (gain) can be determined from the diagram
 - Peak fitting
 - Fast Fourier transformation



Photoelectron spectrum

Events 2000 All pixels produce Integration Δt nearly the same charge 1 pe 2 pe (peaks can be easily separated) **3** pe Amplification (gain) can 2000 be determined from the **0** pe diagram 1500 **4 pe** Peak fitting *** 1000 Fast Fourier 5 pe transformation 500 **0**0 20 **40** 80 120 160 180 **60** 140 100 **Charge** [QDC-Channels]

0

0

Photoelectron spectrum

Events 2000 All pixels produce Integration Δt nearly the same charge 1 pe 2 pe (peaks can be easily separated) **3 pe** Amplification (gain) can 2000 gain be determined from the **0** pe diagram 1500 **4 pe** Peak fitting *** 1000 Fast Fourier **5 pe** transformation **500 0**0 20 **40** 80 160 180 **60** 140 120 100 **Charge** [QDC-Channels]

0

0

je dependence

Gain vs. over-voltage



Temperature dependence



Photon detection efficiency

• Definition:

 $PDE = \frac{Number \ of \ detected \ photons}{Number \ incident \ photons}$

• In case of a SiPM:

A

$$PDE = \epsilon_{geo} \cdot QE \cdot \epsilon_{trigger}$$

$$\epsilon_{geo} = \frac{A_{sensitive}}{A_{total}}$$
$$QE = Quantum \ efficiency$$

 $\epsilon_{trigger}$ = avalanche trigger probability depends on U_{over} and position (λ)





• PDE measurement is difficult because of cross-talk and after-pulsing

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single photon detection



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• PDE measurement is difficult because of cross-talk and after-pulsing



If this effect is not considered in the measurement you will measure too large values for the PDE (values larger than one possible)

→ Need a method which is insensitive to cross-talk and after-pulses

PDE measurement setup











PDE Setup



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PDE vs. Uover











Spectral Sensitivity









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PDE Results: MPPC



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PDE Results: MPPC



Uniformity Scans

Setup



- Move spot over SiPM surface
- QDC readout (30ns gate)

10,000 events per geom. position

- $3\mu m$ step size \Rightarrow 123,000 positions
- Total time (1×1mm²): ≈100h



Single Pixel Spectrum



Single Pixel Spectrum



Single Pixel Spectrum





MPPC 100 pixels



MPPC 400 pixels



0.8

0.6

0.4

0.2

0

0.2

- High uniformity in sensitivity and 0 gain
- Cross-talk shows strong position 0 dependence

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0.4

12

10

8

6

4

2

0

1

x [mm]

0.8

0.6

MPPC 1600 pixels



Enjoy the hands-on sessions!

References

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Backup Slides

Saturation function

 The maximum number of photons that can be detected is fundamentally limited by the total number of pixels N_{total}

1000

 More pixels -> Higher dynamical range, but also smaller geometrical efficiency and smaller gain

$$N_{fired} = N_{total} \left(1 - e^{-\frac{N_{\gamma}PDE}{N_{total}}}\right)$$

 If the recovery time of a cell is smaller than the width of the light pulse, pixels can fire multiple times which causes a larger number of "effective" pixels



V. Andreev et. al., A high granularity scintillator hadronic-calorimeter with SiPM readout for a linear collider detector, Nucl. Instrum. Meth. A 540 (2005) 368

- Equation above not valid anymore (correction difficult)

Dark-rate Correction

The number of photoelectrons needs to be corrected for the dark-rate.

 \rightarrow Acquire dark-rate spectrum at each voltage value.

Correction factor α :

$$\alpha \cdot N_{ped}^{dark} = N_{ped}^{dark*} \stackrel{!}{=} N_{tot}^{dark}$$
$$\Rightarrow \alpha = \frac{N_{tot}^{dark}}{N_{ped}^{dark}}$$



$$n_{pe} = -ln\left(\frac{\alpha \cdot N_{ped}}{N_{tot}}\right) = -ln\left(\frac{N_{ped}}{N_{tot}}\right) + ln\left(\frac{N_{tot}^{dark}}{N_{ped}^{dark}}\right)$$

Measurement of Power-ratio



SiPM Positioning

- All light should hit the active SiPM-Surface.
- Ø=0.6mm aperture was used for measurements with pulsed laser-diodes.
- Plateau on top allows reproducible positioning at maximum

SiPM

